

December 2011

# KA2803B Earth Leakage Detector

### **Features**

- Low Power Consumption: 5mW, 100V/200V
- Built-In Voltage Regulator
- High-Gain Differential Amplifier
- 0.4mA Output Current Pulse to Trigger SCRs
- Low External Part Count
- DIP & SOP Packages, High Packing Density
- High Noise Immunity, Large Surge Margin
- Super Temperature Characteristic of Input Sensitivity
- Wide Operating Temperature Range:
   T<sub>A</sub> = -25°C to +80°C
- Operation from 12V to 20V Input

### **Functions**

- Differential Amplifier
- Level Comparator
- Latch Circuit

## Description

The KA2803B is designed for use in earth leakage circuit interrupters, for operation directly off the AC line in breakers. The input of the differential amplifier is connected to the secondary coil of ZCT (Zero Current Transformer). The amplified output of differential amplifier is integrated at external capacitor to gain adequate time delay specified in KSC4613. The level comparator generates a high level when earth leakage current is greater than the fixed level.



8-DIP



8-SOP

## **Ordering Information**

Part Number	<b>Operating Temperature Range</b>	Package	Packing Method	
KA2803B	-25 to +80°C	8-Lead, Dual Inline Package (DIP)	Tube	
KA2803BD	-25 to +80°C	8-Lead, Small Outline Package (SOP)	Tape and Reel	

### **Block Diagram**

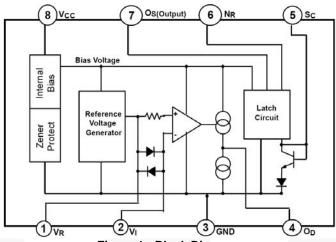
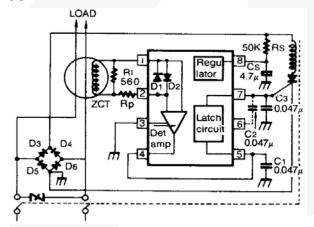
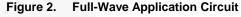


Figure 1. Block Diagram

## **Application Circuit**





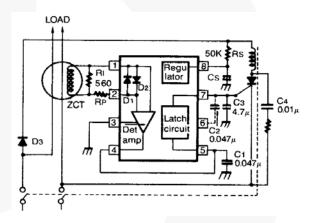


Figure 3. Half-Wave Application Circuit

### **Application Information**

(Refer to full-wave application circuit in Figure 2)

Figure 2 shows the KA2803B connected in a typical leakage current detector system. The power is applied to the  $V_{CC}$  terminal (Pin 8) directly from the power line. The resistor  $R_{\rm S}$  and capacitor  $C_{\rm S}$  are chosen so that Pin 8 voltage is at least 12V. The value of  $C_{\rm S}$  is recommended above  $1\mu F.$ 

If the leakage current is at the load, it is detected by the zero current transformer (ZCT). The output voltage signal of ZCT is amplified by the differential amplifier of the KA2803B internal circuit and appears as a half-cycle sine wave signal referred to input signal at the output of the amplifier. The amplifier closed-loop gain is fixed about 1000 times with internal feedback resistor to compensate for zero current transformer (ZCT) variations. The resistor  $R_{\rm L}$  should be selected so that the breaker satisfies the required sensing current. The protection resistor  $R_{\rm P}$  is not usually used when high current is injected at the breaker; this resistor should be

used to protect the earth leakage detector IC (KA2803B). The range of R<sub>P</sub> is from several hundred  $\Omega$  to several k $\Omega$ .

Capacitor  $C_1$  is for the noise canceller and a standard value of  $C_1$  is 0.047 $\mu$ F. Capacitor C2 is also a noise canceller capacitance, but it is not usually used.

When high noise is present, a  $0.047\mu F$  capacitor may be connected between Pins 6 and 7. The amplified signal finally appears at the Pin 7 with pulse signal through the internal latch circuit of the KA2803B. This signal drives the gate of the external SCR, which energizes the trip coil, which opens the circuit breaker. The trip time of the breaker is determined by capacitor  $C_3$  and the mechanism breaker. This capacitor should be selected under  $1\mu F$  to satisfy the required trip time. The full-wave bridge supplies power to the KA2803B during both the positive and negative half cycles of the line voltage. This allows the hot and neutral lines to be interchanged.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
V <sub>cc</sub>	Supply Voltage		20	V	
I <sub>CC</sub>	Supply Current		8	mA	
$P_{D}$	Power Dissipation		300	mW	
TL	Lead Temperature, Soldering 10 Seconds		260	°C	
T <sub>A</sub>	Operation Temperature Range	-25	+80	°C	
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C	

### **Electrical Characteristics**

 $T_A = -25$ °C to +80°C unless otherwise specified.

Symbol	Parameter	Conditions		Test Circuit	Min.	Тур.	Max.	Unit s
	Supply Current 1	V <sub>CC</sub> =12V	T <sub>A</sub> = -25°C	;			580	μA
I <sub>CC</sub>		$V_R$ =OPEN $T_A$ = +25°C $T_A$ = +80°C	$T_A = +25^{\circ}$	C Figure 4	300	400	530	
			0			480		
$V_{T}$	Trip Voltage	$V_{CC}$ =16V, $V_{R}$ =2V~2.02V, $V_{I}$ =2		V, Figure 5	14	16	18	mV
·		Note 1		12.5	14.2	17.0	(ms)	
	Differential Amplifier Current Current 1	$\begin{aligned} & V_{\text{CC}} \!\!=\! 16 \text{V},  V_{\text{R}} \!\!\!\sim\! V_{\text{I}} \!\!\!=\! 30 \text{mV}, \\ & V_{\text{OD}} \!\!\!=\! 1.2 \text{V} \\ & V_{\text{CC}} \!\!\!=\! 16 \text{V},  V_{\text{OD}} \!\!\!=\! 0.8 \text{V}, \! V_{\text{R}}, \\ & V_{\text{I}}  \text{Short} \!\!\!=\! V_{\text{P}} \end{aligned}$		Figure 7	-12	20	-30	μA
I <sub>O(D)</sub>	Differential Amplifier Current Current 2			Figure 8	17	27	37	
Io	Output Current	V <sub>SC</sub> =1.4V, V <sub>OS</sub> =0.8V,	T <sub>A</sub> = -25°C	;	200	400	800	μA
			$T_A = +25^{\circ}$	C Figure 9	200	400	800	
			$T_A = +80^{\circ}$	С	100	300	600	
$V_{SCON}$	Latch-On Voltage	V <sub>CC</sub> =16V		Figure 10	0.7	1.0	1.4	V
I <sub>SCON</sub>	Latch Input Current	V <sub>CC</sub> =16V		Figure 11	-13	-7	-1	μA
I <sub>OSL</sub>	Output Low Current	V <sub>CC</sub> =12V, V <sub>OSL</sub> =0.2V		Figure 12	200	800	1400	μA
$V_{IDC}$	Differential Input Clamp Voltage	V <sub>CC</sub> =16V, I <sub>IDC</sub> =100mA		Figure 13	0.4	1.2	2.0	V
$V_{SM}$	Maximum Current Voltage	I <sub>SM</sub> =7mA		Figure 14	20	24	28	V
I <sub>S2</sub>	Supply Current 2	V <sub>CC</sub> =12.0V, V <sub>OSL</sub> =0.6V		Figure 15	200	400	900	μA
$V_{SOFF}$		V <sub>OS</sub> =12.0V V <sub>SC</sub> =1.8V			7	8	9	V
	Latch-Off Supply Voltage			Figure 16				
		I <sub>IDC</sub> =100.0mA						
t <sub>ON</sub>	Response Time	$V_{CC}$ =16V, $V_{R}$ - $V_{I}$ =0.3V, 1V< $V_{X}$ <5V		Figure 17	2	3	4	ms

#### Note:

1. Guaranteed by design, not tested in production.

## **Test Circuits**

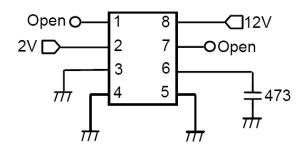


Figure 4. Supply Current 1

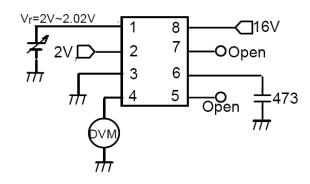


Figure 5. Trip Voltage

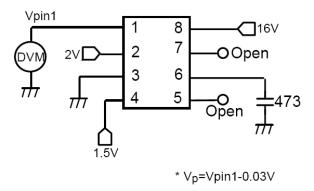


Figure 6. V<sub>PN1</sub> for V<sub>P</sub> Measurement

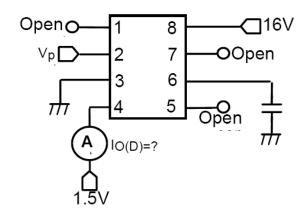


Figure 7. Differential Amplifier Output Current 1

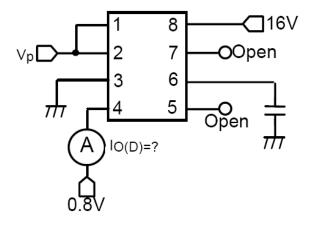


Figure 8. Differential Amplifier Output Current 2

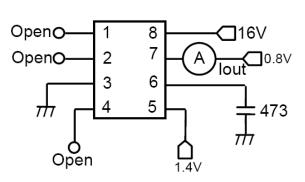


Figure 9. Output Current

## Test Circuits (Continued)

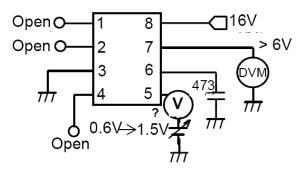
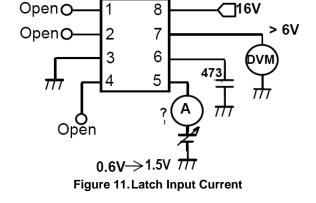


Figure 10. Latch-On Voltage



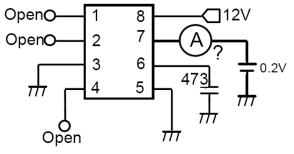


Figure 12. Output Low Current

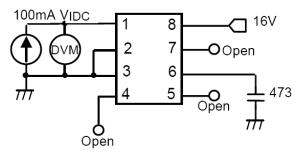


Figure 13. Differential Input Clamp Voltage

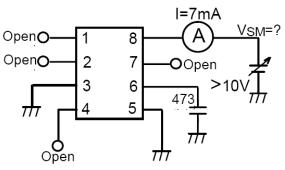


Figure 14. Maximum Current Voltage

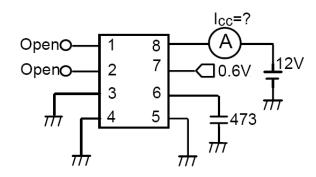


Figure 15. Supply Current 2

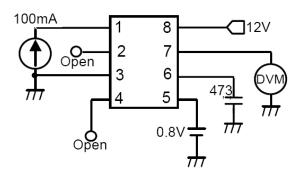


Figure 16. Latch-Off Supply Voltage

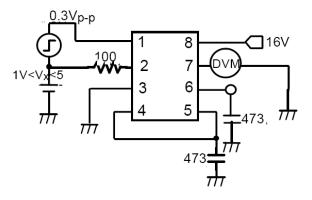


Figure 17. Response Time

## **Typical Performance Characteristics**

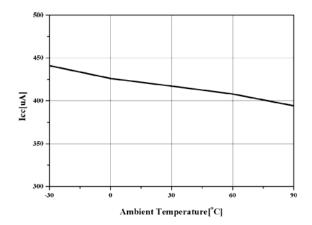


Figure 18. Supply Current

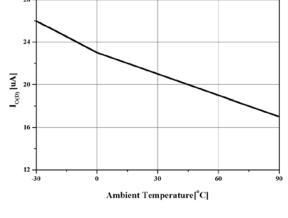


Figure 19. Differential Amplifier Output Current  $(V_R-V_I=30mV, V_{OD}=1.2V)$ 

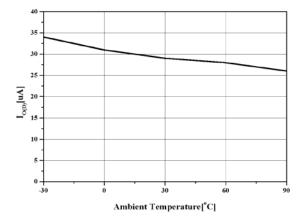


Figure 20. Differential Amplifier Output Current  $(V_R, V_I=V_P, V_{OD}=0.8V)$ 

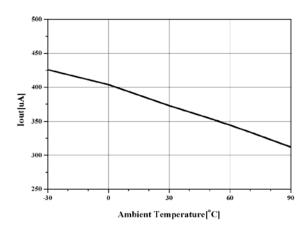


Figure 21. Output Current

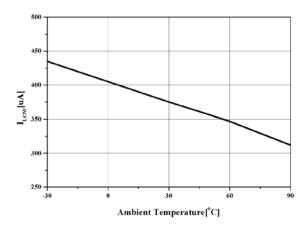


Figure 22. Output Low Current

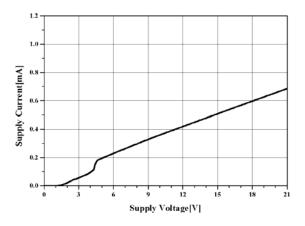
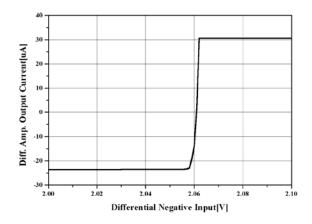


Figure 23. V<sub>CC</sub> Voltage vs. Supply Current 1

## **Typical Performance Characteristics** (Continued)



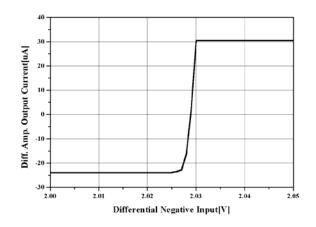
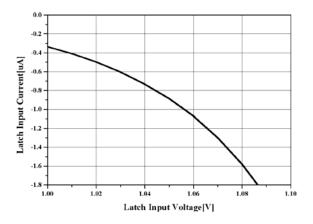


Figure 24. Differential Amplifier Output Current 1

Figure 25. Differential Amplifier Output



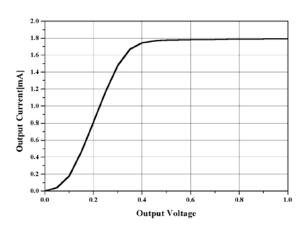
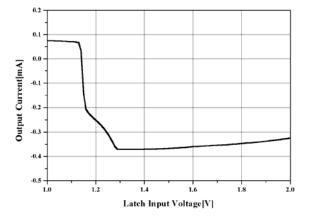


Figure 26. Latch Input Current

Figure 27. Output Low Current



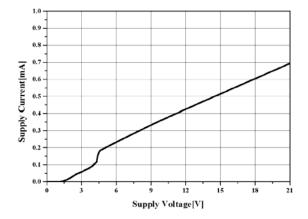


Figure 28. Output Current

Figure 29. V<sub>CC</sub> Voltage vs. Supply Current 2

## **Typical Performance Characteristics** (Continued)

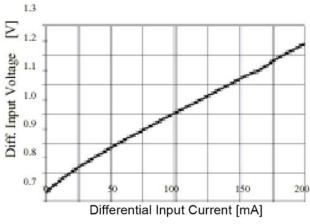
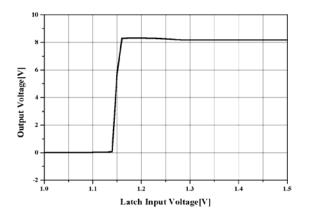


Figure 30. Differential Input Clamp Voltage

Figure 31. Latch-Off Supply Voltage



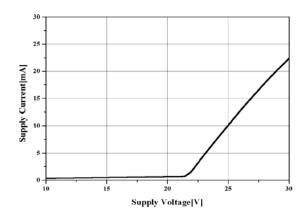
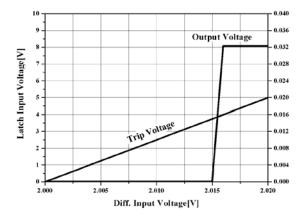


Figure 32. Latch-On Input Voltage

Figure 33. Maximum Supply



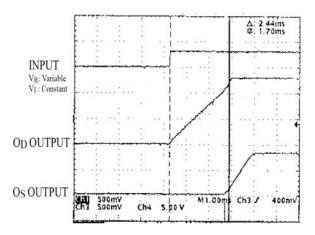
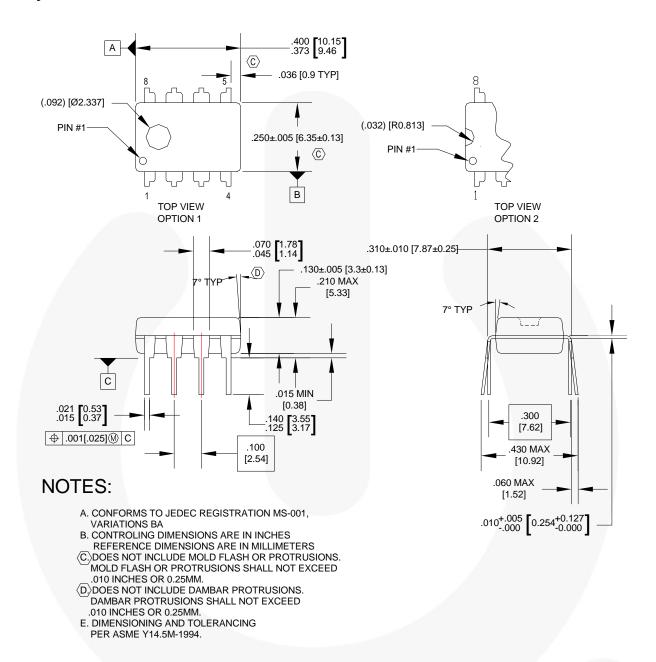


Figure 34. Trip and Output

Figure 35. Output Response Time

## **Physical Dimensions**



## N08EREVG

### Figure 36. 8-Lead, Dual Inline Package (DIP)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.

## **Physical Dimensions**

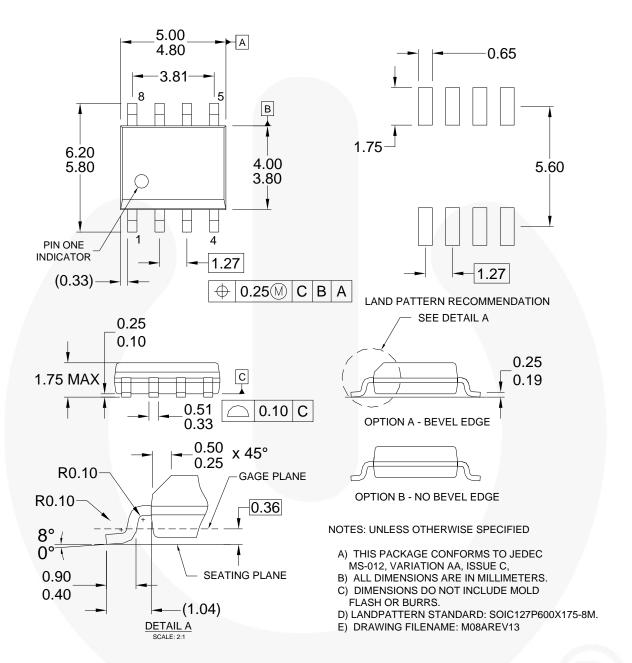


Figure 37. 8-Lead, Small Outline Package (SOP)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.





#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

 2Cool™
 FPS™

 AccuPower™
 F-PFS™

 Auto-SPM™
 FRFET®

 Ax\_CAP™\*
 Global Power Resource®

 AX-CAP™\*
 Global Power Resource

 BitSiC™
 GreenBridge™

 Build it Now™
 Green FPS™

 CorePLUS™
 Green FPS™ e-Series™

 CorePOWER™
 Gmax™

 CROSSVOLT™
  $GTO^{TM}$  

 CTL™
 IntelliMAX™

 Current Transfer Logic™
 ISOPLANAR™

DEUXPEED® Making Small Speakers Sound Louder

MicroPak2™

MillerDrive™

MotionMax™

mWSaver™

OptoHiT™

Motion-SPM™

OPTOLOGIC<sup>®</sup>

OPTOPLANAR®

DEUXPEED™ Making Small Speak
Dual Cool™ and Better™
EcoSPARK® MegaBuck™ MICROCOUPLER™
ESBC™ MicroFET™
MicroPak™

Fairchild<sup>®</sup>
Fairchild Semiconductor<sup>®</sup>
FACT Quiet Series™
FACT<sup>®</sup>
FAST<sup>©</sup>
FastvCore™
FETBench™

PowerTrench<sup>®</sup> PowerXS™

Programmable Active Droop™

QFET®
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™

SmartMax™ SMART START™

Solutions for Your Success™

Solutions for Your SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™

Sync-Lock™
SYSTEM
GENERAL®\*



Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FlashWriter®\*

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS, THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a)
  are intended for surgical implant into the body or (b) support or
  sustain life, and (c) whose failure to perform when properly used in
  accordance with instructions for use provided in the labeling, can be
  reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

atus	Definition
	Bennidon
Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
ction	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
ction	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
uction	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	Design ction ction

Rev. 160